

CR12CM-12A

Thyristor

Medium Power Use

REJ03G0350-0200

Rev.2.00

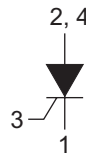
Nov 30, 2007

Features

- $I_{T(AV)}$: 12 A
- V_{DRM} : 600 V
- I_{GT} : 30 mA
- Non-Insulated Type
- Planar Passivation Type

Outline

RENESAS Package code: PRSS0004AA-A
(Package name: TO-220)



1. Cathode
2. Anode
3. Gate
4. Anode

Applications

Switching mode power supply, regulator for autcycle, motor control, heater control, and other general purpose control applications

Maximum Ratings

Parameter	Symbol	Voltage class	Unit
		12	
Repetitive peak reverse voltage	V_{RRM}	600	V
Non-repetitive peak reverse voltage	V_{RSM}	720	V
DC reverse voltage	$V_{R(DC)}$	480	V
Repetitive peak off-state voltage	V_{DRM}	600	V
DC off-state voltage	$V_{D(DC)}$	480	V

Parameter	Symbol	Ratings	Unit	Conditions
RMS on-state current	$I_T (RMS)$	18.8	A	
Average on-state current	$I_T (AV)$	12	A	Commercial frequency, sine half wave 180° conduction, $T_c = 91^{\circ}C$ ^{Note2}
Surge on-state current	I_{TSM}	360	A	60Hz sine half wave 1 full cycle, peak value, non-repetitive
I^2t for fusing	I^2t	544	A^2s	Value corresponding to 1 cycle of half wave 60Hz, surge on-state current
Peak gate power dissipation	P_{GM}	5	W	
Average gate power dissipation	$P_G (AV)$	0.5	W	
Peak gate forward voltage	V_{FGM}	6	V	
Peak gate reverse voltage	V_{RGM}	10	V	
Peak gate forward current	I_{FGM}	2	A	
Junction temperature	T_j	– 40 to +125	$^{\circ}C$	
Storage temperature	T_{stg}	– 40 to +125	$^{\circ}C$	
Mass	—	2.0	g	Typical value

Electrical Characteristics

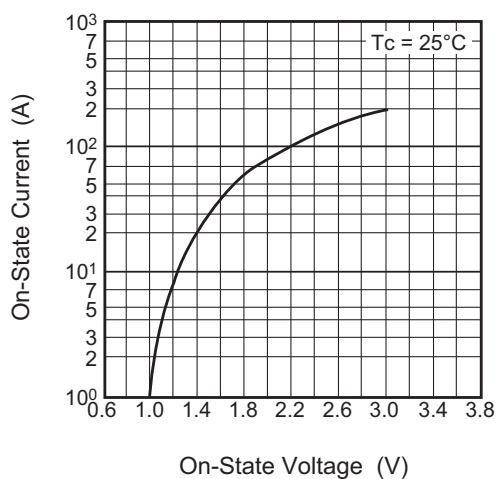
Parameter	Symbol	Min.	Typ.	Max.	Unit	Test conditions
Repetitive peak reverse current	I_{RRM}	—	—	2.0	mA	$T_j = 125^{\circ}C$, V_{RRM} applied
Repetitive peak off-state current	I_{DRM}	—	—	2.0	mA	$T_j = 125^{\circ}C$, V_{DRM} applied
On-state voltage	V_{TM}	—	—	1.6	V	$T_c = 25^{\circ}C$, $I_{TM} = 40$ A, instantaneous value
Gate trigger voltage	V_{GT}	—	—	1.5	V	$T_j = 25^{\circ}C$, $V_D = 6$ V, $I_T = 1$ A
Gate non-trigger voltage	V_{GD}	0.2	—	—	V	$T_j = 125^{\circ}C$, $V_D = 1/2 V_{DRM}$
Gate trigger current	I_{GT}	—	—	30	mA	$T_j = 25^{\circ}C$, $V_D = 6$ V, $I_T = 1$ A
Holding current	I_H	—	15	—	mA	$T_j = 25^{\circ}C$, $V_D = 12$ V
Thermal resistance	$R_{th (j-c)}$	—	—	1.2	$^{\circ}C/W$	Junction to case ^{Note1 Note2}

Notes: 1. The contact thermal resistance $R_{th (c-f)}$ in case of greasing is $1.0^{\circ}C/W$.

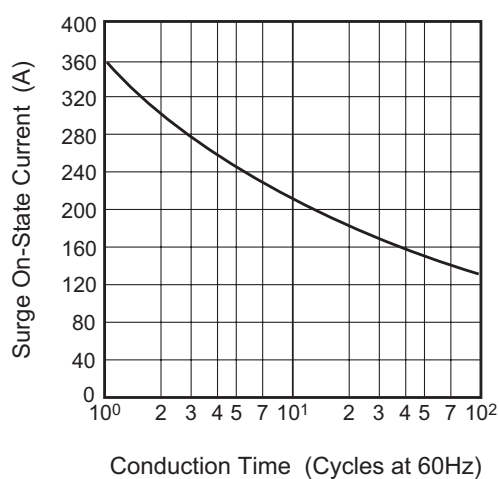
2. Case temperature is measured at anode tab 1.5 mm away from the molded case.

Performance Curves

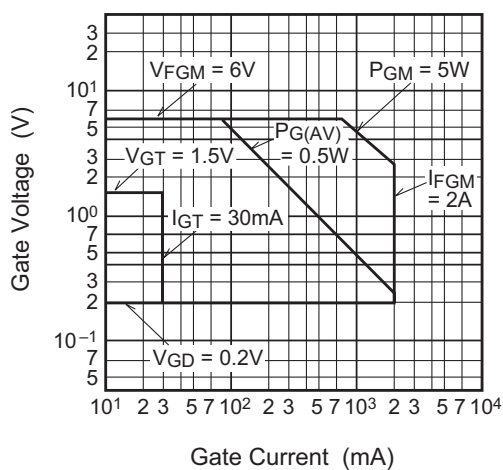
Maximum On-State Characteristics



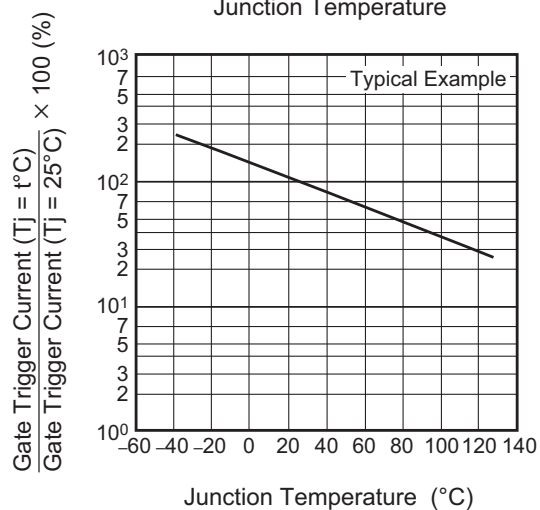
Rated Surge On-State Current



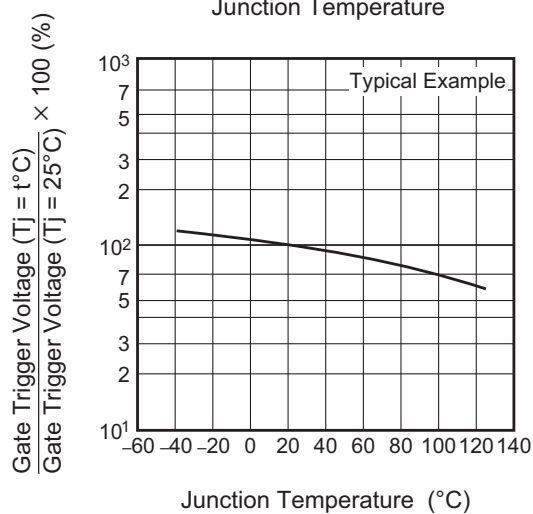
Gate Characteristics



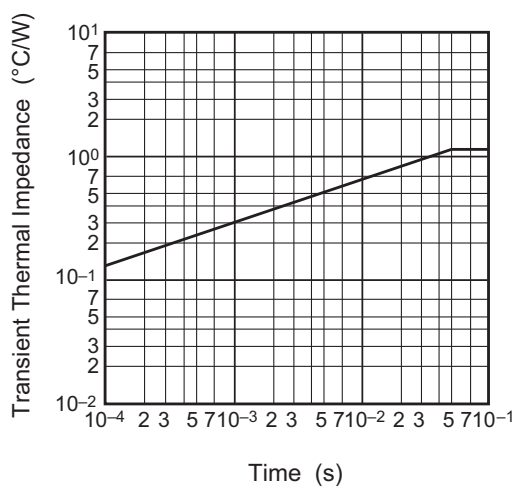
Gate Trigger Current vs. Junction Temperature



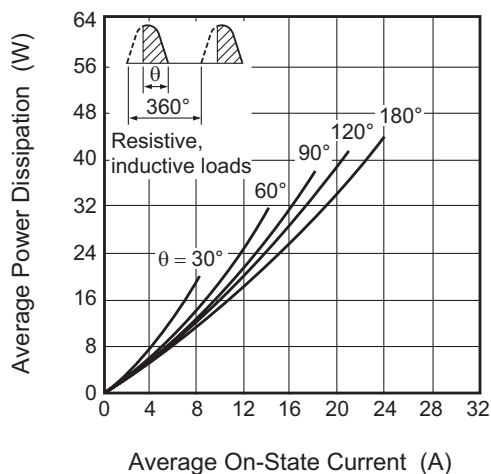
Gate Trigger Voltage vs. Junction Temperature



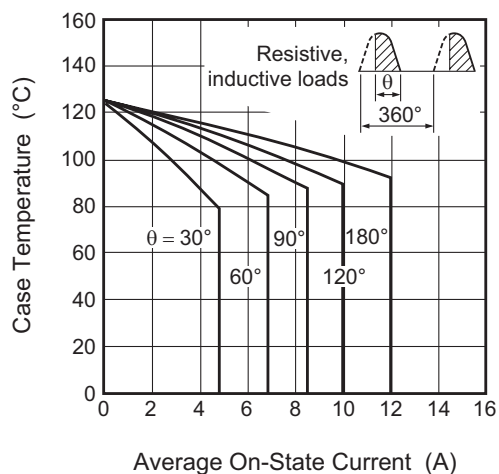
Maximum Transient Thermal Impedance Characteristics (Junction to case)



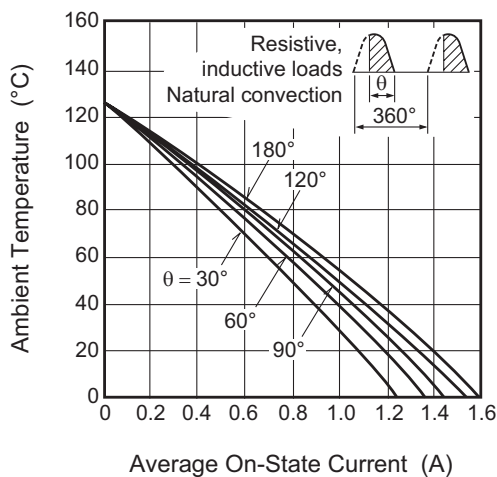
Maximum Average Power Dissipation
(Single-Phase Half Wave)



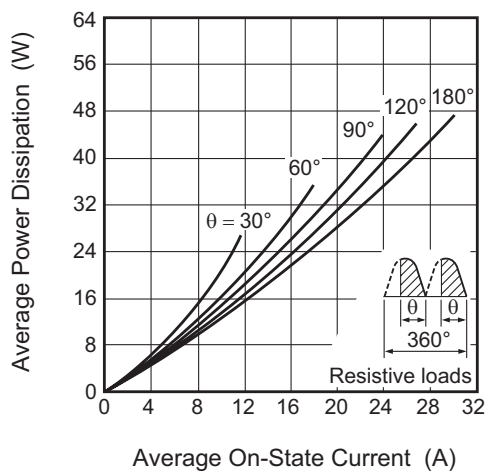
Allowable Case Temperature vs.
Average On-State Current
(Single-Phase Half Wave)



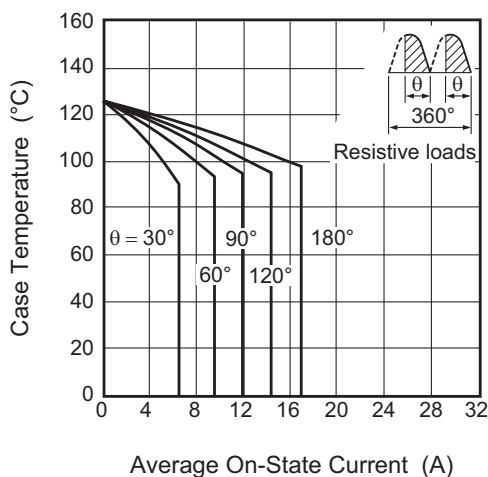
Allowable Ambient Temperature vs.
Average On-State Current
(Single-Phase Half Wave)



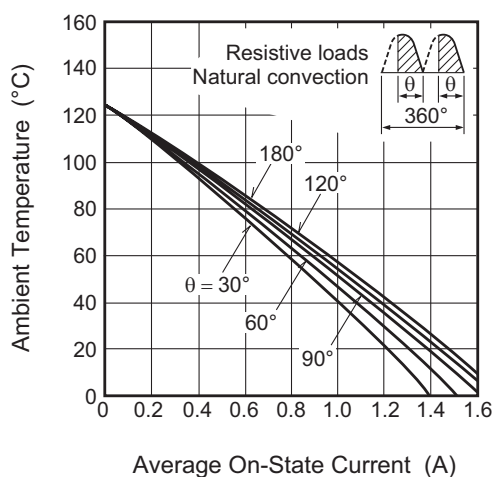
Maximum Average Power Dissipation
(Single-Phase Full Wave)

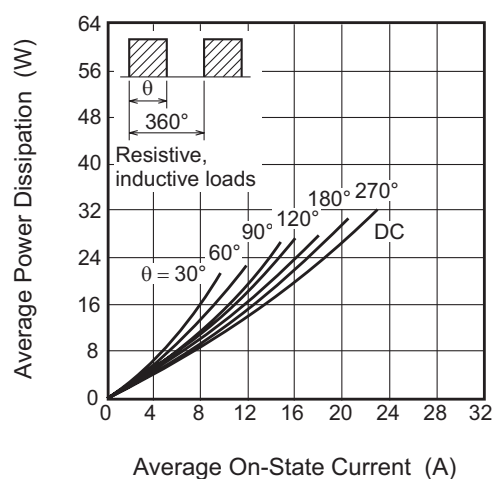
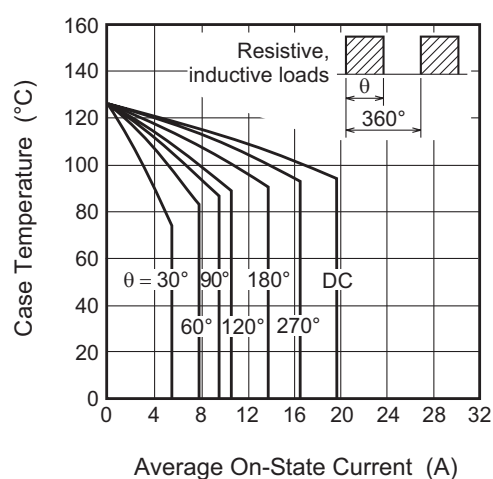
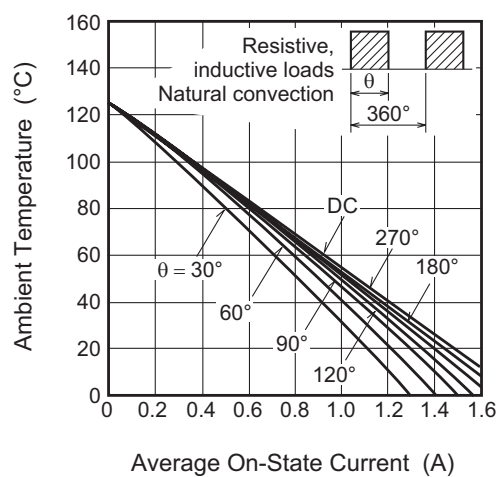
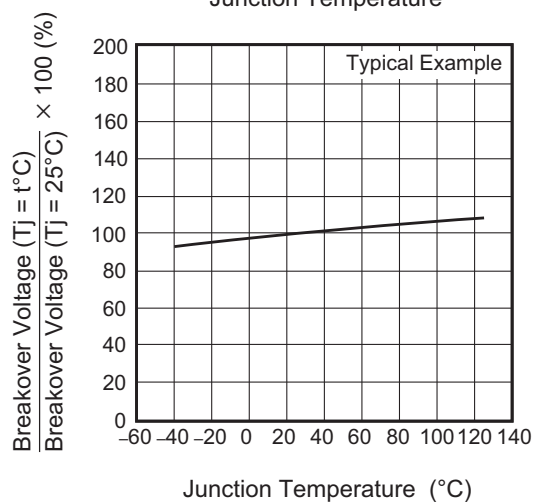
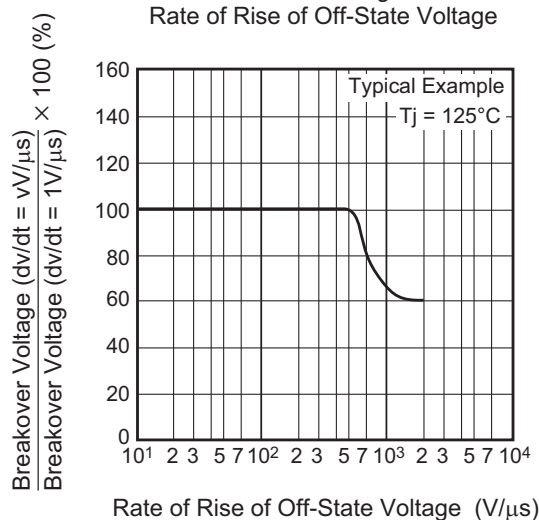
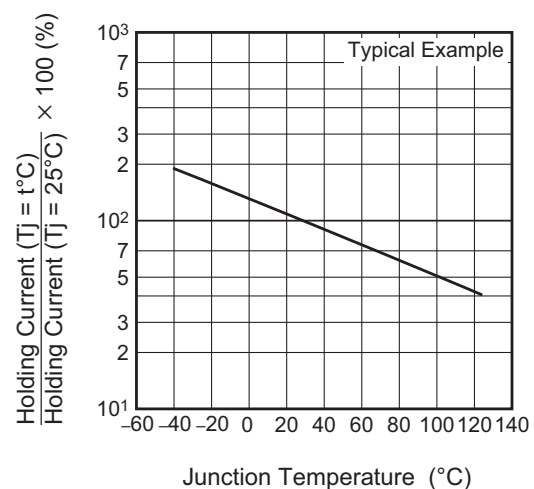


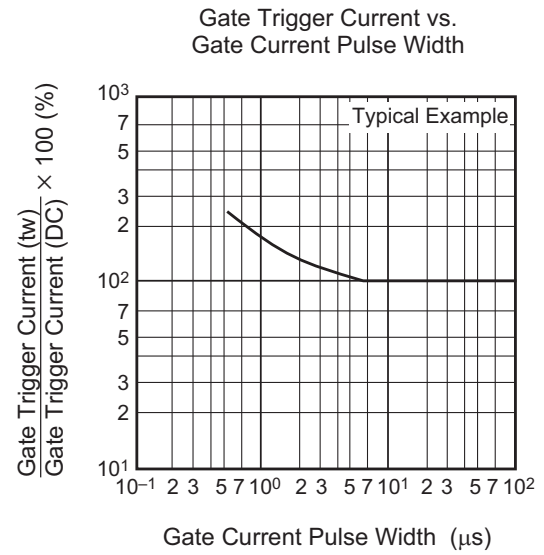
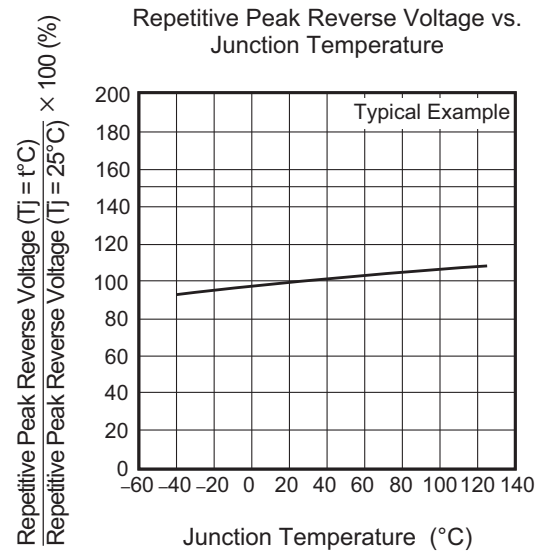
Allowable Case Temperature vs.
Average On-State Current
(Single-Phase Full Wave)



Allowable Ambient Temperature vs.
Average On-State Current
(Single-Phase Full Wave)



Maximum Average Power Dissipation
(Rectangular Wave)Allowable Case Temperature vs.
Average On-State Current
(Rectangular Wave)Allowable Ambient Temperature vs.
Average On-State Current
(Rectangular Wave)Breakover Voltage vs.
Junction TemperatureBreakover Voltage vs.
Rate of Rise of Off-State VoltageHolding Current vs.
Junction Temperature



Package Dimensions

Package Name	JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]	Unit: mm
TO-220	SC-46	PRSS0004AA-A	—	2.0g	

The drawing shows the mechanical specifications of the CR12CM-12A package. The top view shows a square body with a maximum width of 10.5 mm and a maximum height of 16 mm. A circular feature with a diameter of 3.6 mm is located on the top surface. The side view shows a maximum height of 12.5 mm and a maximum width of 4.5 mm. The lead view shows a maximum length of 3.8 mm and a maximum width of 2.54 mm. The lead pitch is 1.0 mm, and the lead thickness is 0.8 mm. The lead angle is 4.5 degrees.

Order Code

Lead form	Standard packing	Quantity	Standard order code	Standard order code example
Straight type	Vinyl sack	100	Type name	CR12CM-12A
Lead form	Plastic Magazine (Tube)	50	Type name – Lead forming code	CR12CM-12A-A8

Note : Please confirm the specification about the shipping in detail.

Notes:

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